

# SN54AHC367, SN74AHC367 HEX BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

SCLS424E – JUNE 1998 – REVISED FEBRUARY 2002

- Operating Range 2-V to 5.5-V  $V_{CC}$
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

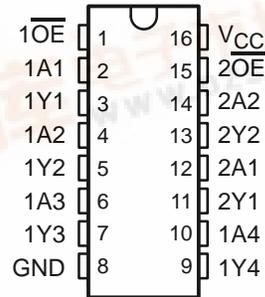
## description

The 'AHC367 devices are hex buffers and line drivers designed for 2-V to 5.5-V  $V_{CC}$  operation.

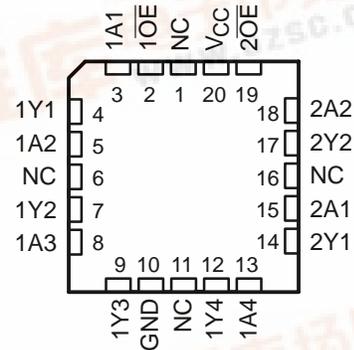
These devices are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The 'AHC367 devices are organized as dual 4-line and 2-line buffers/drivers with active-low output-enable ( $\overline{1OE}$  and  $\overline{2OE}$ ) inputs. When  $\overline{OE}$  is low, the device passes noninverted data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

SN54AHC367 ... J OR W PACKAGE  
SN74AHC367 ... D, DB, DGV, N, OR PW PACKAGE  
(TOP VIEW)



SN54AHC367 ... FK PACKAGE  
(TOP VIEW)



NC – No internal connection

## ORDERING INFORMATION

| TA             | PACKAGE†    |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|---------------|-----------------------|------------------|
| –40°C to 85°C  | PDIP – N    | Tube          | SN74AHC367N           | SN74AHC367N      |
|                | SOIC – D    | Tube          | SN74AHC367D           | AHC367           |
|                |             | Tape and reel | SN74AHC367DR          |                  |
|                | SSOP – DB   | Tape and reel | SN74AHC367DBR         | HA367            |
|                | TSSOP – PW  | Tape and reel | SN74AHC367PWR         | HA367            |
|                | TVSOP – DGV | Tape and reel | SN74AHC367DGV         | HA367            |
| –55°C to 125°C | CDIP – J    | Tube          | SNJ54AHC367J          | SNJ54AHC367J     |
|                | CFP – W     | Tube          | SNJ54AHC367W          | SNJ54AHC367W     |
|                | LCCC – FK   | Tube          | SNJ54AHC367FK         | SNJ54AHC367FK    |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



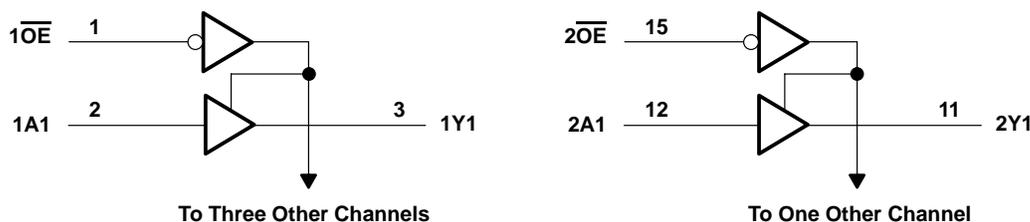
# SN54AHC367, SN74AHC367 HEX BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

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FUNCTION TABLE  
(each buffer/driver)

| INPUTS          |   | OUTPUT |
|-----------------|---|--------|
| $\overline{OE}$ | A | Y      |
| L               | H | H      |
| L               | L | L      |
| H               | X | Z      |

## logic diagram (positive logic)



Pin numbers shown are for the D, DB, DGV, J, N, PW, and W packages.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

|  |                            |
|--|----------------------------|
| Supply voltage range, $V_{CC}$                                 | -0.5 V to 7 V              |
| Input voltage range, $V_I$ (see Note 1)                        | -0.5 V to 7 V              |
| Output voltage range, $V_O$ (see Note 1)                       | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                    | -20 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) | $\pm 20$ mA                |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )     | $\pm 25$ mA                |
| Continuous current through $V_{CC}$ or GND                     | $\pm 75$ mA                |
| Package thermal impedance, $\theta_{JA}$ (see Note 2):         |                            |
| D package  | 73°C/W                     |
| DB package   | 82°C/W                     |
| DGV package  | 120°C/W                    |
| N package  | 67°C/W                     |
| PW package   | 108°C/W                    |
| Storage temperature range, $T_{stg}$                           | -65°C to 150°C             |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.

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## recommended operating conditions (see Note 3)

|                 |                                    | SN54AHC367                      |                 | SN74AHC367 |                 | UNIT |
|-----------------|------------------------------------|---------------------------------|-----------------|------------|-----------------|------|
|                 |                                    | MIN                             | MAX             | MIN        | MAX             |      |
| V <sub>CC</sub> | Supply voltage                     | 2                               | 5.5             | 2          | 5.5             | V    |
| V <sub>IH</sub> | High-level input voltage           | V <sub>CC</sub> = 2 V           |                 | 1.5        |                 | V    |
|                 |                                    | V <sub>CC</sub> = 3 V           |                 | 2.1        |                 |      |
|                 |                                    | V <sub>CC</sub> = 5.5 V         |                 | 3.85       |                 |      |
| V <sub>IL</sub> | Low-level input voltage            | V <sub>CC</sub> = 2 V           |                 | 0.5        |                 | V    |
|                 |                                    | V <sub>CC</sub> = 3 V           |                 | 0.9        |                 |      |
|                 |                                    | V <sub>CC</sub> = 5.5 V         |                 | 1.65       |                 |      |
| V <sub>I</sub>  | Input voltage                      | 0                               | 5.5             | 0          | 5.5             | V    |
| V <sub>O</sub>  | Output voltage                     | 0                               | V <sub>CC</sub> | 0          | V <sub>CC</sub> | V    |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 2 V           |                 | -50        |                 | μA   |
|                 |                                    | V <sub>CC</sub> = 3.3 V ± 0.3 V |                 | -4         |                 |      |
|                 |                                    | V <sub>CC</sub> = 5 V ± 0.5 V   |                 | -8         |                 |      |
| I <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 2 V           |                 | 50         |                 | μA   |
|                 |                                    | V <sub>CC</sub> = 3.3 V ± 0.3 V |                 | 4          |                 |      |
|                 |                                    | V <sub>CC</sub> = 5 V ± 0.5 V   |                 | 8          |                 |      |
| Δt/Δv           | Input transition rise or fall rate | V <sub>CC</sub> = 3.3 V ± 0.3 V |                 | 100        |                 | ns/V |
|                 |                                    | V <sub>CC</sub> = 5 V ± 0.5 V   |                 | 20         |                 |      |
| T <sub>A</sub>  | Operating free-air temperature     | -55                             | 125             | -40        | 85              | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS  | V <sub>CC</sub> | T <sub>A</sub> = 25°C |     |     | SN54AHC367 |     | SN74AHC367 |     | UNIT |
|-----------------|--|-----------------|-----------------------|-----|-----|------------|-----|------------|-----|------|
|                 |  |                 | MIN                   | TYP | MAX | MIN        | MAX | MIN        | MAX |      |
| V <sub>OH</sub> | I <sub>OH</sub> = -50 μA   | 2 V             | 1.9                   | 2   |     | 1.9        |     | 1.9        | V   |      |
|                 |  | 3 V             | 2.9                   | 3   |     | 2.9        |     | 2.9        |     |      |
|                 |  | 4.5 V           | 4.4                   | 4.5 |     | 4.4        |     | 4.4        |     |      |
|                 | I <sub>OH</sub> = -4 mA  | 3 V             | 2.58                  |     |     | 2.48       |     | 2.48       |     |      |
|                 | I <sub>OH</sub> = -8 mA  | 4.5 V           | 3.94                  |     |     | 3.8        |     | 3.8        |     |      |
| V <sub>OL</sub> | I <sub>OL</sub> = 50 μA  | 2 V             |                       |     |     | 0.1        |     | 0.1        | V   |      |
|                 |  | 3 V             |                       |     |     | 0.1        |     | 0.1        |     |      |
|                 |  | 4.5 V           |                       |     |     | 0.1        |     | 0.1        |     |      |
|                 | I <sub>OL</sub> = 4 mA   | 3 V             |                       |     |     | 0.36       |     | 0.44       |     |      |
|                 | I <sub>OL</sub> = 8 mA   | 4.5 V           |                       |     |     | 0.36       |     | 0.5        |     |      |
| I <sub>I</sub>  | V <sub>I</sub> = 5.5 V or GND  | 0 V to 5.5 V    |                       |     |     | ±0.1       |     | ±1*        | μA  |      |
| I <sub>OZ</sub> | V <sub>I</sub> = V <sub>CC</sub> or GND, V <sub>O</sub> = V <sub>CC</sub> or GND, OE = V <sub>IH</sub> | 5.5 V           |                       |     |     |            |     | ±2.5       | μA  |      |
| I <sub>CC</sub> | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0  | 5.5 V           |                       |     |     | 4          |     | 40         | μA  |      |
| C <sub>i</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND  | 5 V             |                       |     |     | 3          |     | 10         | pF  |      |
| C <sub>o</sub>  | V <sub>O</sub> = V <sub>CC</sub> or GND  | 5 V             |                       |     |     | 5.1        |     |            | pF  |      |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested at V<sub>CC</sub> = 0 V.

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switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT)    | TO (OUTPUT) | LOAD CAPACITANCE     | $T_A = 25^\circ\text{C}$ |       |     | SN54AHC367 |     | SN74AHC367 |     | UNIT |
|-----------|-----------------|-------------|----------------------|--------------------------|-------|-----|------------|-----|------------|-----|------|
|           |                 |             |                      | MIN                      | TYP   | MAX | MIN        | MAX | MIN        | MAX |      |
| $t_{PLH}$ | A               | Y           | $C_L = 15\text{ pF}$ | 4.7*                     | 8.3*  | 1*  | 10*        | 1   | 10         | ns  |      |
| $t_{PHL}$ |                 |             |                      | 4.7*                     | 8.3*  | 1*  | 10*        | 1   | 10         |     |      |
| $t_{PZH}$ | $\overline{OE}$ | Y           | $C_L = 15\text{ pF}$ | 5.1*                     | 10.5* | 1*  | 12.5*      | 1   | 12.5       | ns  |      |
| $t_{PZL}$ |                 |             |                      | 5.1*                     | 10.5* | 1*  | 12.5*      | 1   | 12.5       |     |      |
| $t_{PHZ}$ | $\overline{OE}$ | Y           | $C_L = 15\text{ pF}$ | 4*                       | 10.5* | 1*  | 12.5*      | 1   | 12.5       | ns  |      |
| $t_{PLZ}$ |                 |             |                      | 4.9*                     | 10.5* | 1*  | 12.5*      | 1   | 12.5       |     |      |
| $t_{PLH}$ | A               | Y           | $C_L = 50\text{ pF}$ | 6.1                      | 11.8  | 1   | 13.5       | 1   | 13.5       | ns  |      |
| $t_{PHL}$ |                 |             |                      | 6.2                      | 11.8  | 1   | 13.5       | 1   | 13.5       |     |      |
| $t_{PZH}$ | $\overline{OE}$ | Y           | $C_L = 50\text{ pF}$ | 6.4                      | 14    | 1   | 16         | 1   | 16         | ns  |      |
| $t_{PZL}$ |                 |             |                      | 6.8                      | 14    | 1   | 16         | 1   | 16         |     |      |
| $t_{PHZ}$ | $\overline{OE}$ | Y           | $C_L = 50\text{ pF}$ | 6.2                      | 13.6  | 1   | 15.5       | 1   | 15.5       | ns  |      |
| $t_{PLZ}$ |                 |             |                      | 7.3                      | 13.6  | 1   | 15.5       | 1   | 15.5       |     |      |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT)    | TO (OUTPUT) | LOAD CAPACITANCE     | $T_A = 25^\circ\text{C}$ |      |     | SN54AHC367 |     | SN74AHC367 |     | UNIT |
|-----------|-----------------|-------------|----------------------|--------------------------|------|-----|------------|-----|------------|-----|------|
|           |                 |             |                      | MIN                      | TYP  | MAX | MIN        | MAX | MIN        | MAX |      |
| $t_{PLH}$ | A               | Y           | $C_L = 15\text{ pF}$ | 3.4*                     | 5.9* | 1*  | 7*         | 1   | 7          | ns  |      |
| $t_{PHL}$ |                 |             |                      | 3.6*                     | 5.9* | 1*  | 7*         | 1   | 7          |     |      |
| $t_{PZH}$ | $\overline{OE}$ | Y           | $C_L = 15\text{ pF}$ | 3.6*                     | 7.2* | 1*  | 8.5*       | 1   | 8.5        | ns  |      |
| $t_{PZL}$ |                 |             |                      | 3.8*                     | 7.2* | 1*  | 8.5*       | 1   | 8.5        |     |      |
| $t_{PHZ}$ | $\overline{OE}$ | Y           | $C_L = 15\text{ pF}$ | 2.6*                     | 7.2* | 0*  | 8.5*       | 0   | 8.5        | ns  |      |
| $t_{PLZ}$ |                 |             |                      | 2.6*                     | 7.2* | 0*  | 8.5*       | 0   | 8.5        |     |      |
| $t_{PLH}$ | A               | Y           | $C_L = 50\text{ pF}$ | 4.3                      | 7.9  | 1   | 9          | 1   | 9          | ns  |      |
| $t_{PHL}$ |                 |             |                      | 4.5                      | 7.9  | 1   | 9          | 1   | 9          |     |      |
| $t_{PZH}$ | $\overline{OE}$ | Y           | $C_L = 50\text{ pF}$ | 4.6                      | 9.2  | 1   | 10.5       | 1   | 10.5       | ns  |      |
| $t_{PZL}$ |                 |             |                      | 4.9                      | 9.2  | 1   | 10.5       | 1   | 10.5       |     |      |
| $t_{PHZ}$ | $\overline{OE}$ | Y           | $C_L = 50\text{ pF}$ | 3.4                      | 9.2  | 0   | 10.5       | 0   | 10.5       | ns  |      |
| $t_{PLZ}$ |                 |             |                      | 4.5                      | 9.2  | 0   | 10.5       | 0   | 10.5       |     |      |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics,  $V_{CC} = 5\text{ V}$ ,  $C_L = 50\text{ pF}$ ,  $T_A = 25^\circ\text{C}$  (see Note 4)

| PARAMETER   |  | SN74AHC367 |      |     | UNIT |
|-------------|--|------------|------|-----|------|
|             |  | MIN        | TYP  | MAX |      |
| $V_{OL(P)}$ | Quiet output, maximum dynamic $V_{OL}$ |            | 0.9  |     | V    |
| $V_{OL(V)}$ | Quiet output, minimum dynamic $V_{OL}$ |            | -0.8 |     | V    |
| $V_{OH(V)}$ | Quiet output, minimum dynamic $V_{OH}$ |            | 4.2  |     | V    |
| $V_{IH(D)}$ | High-level dynamic input voltage       |            | 3.5  |     | V    |
| $V_{IL(D)}$ | Low-level dynamic input voltage        |            |      | 1.5 | V    |

NOTE 4: Characteristics are for surface-mount packages only.

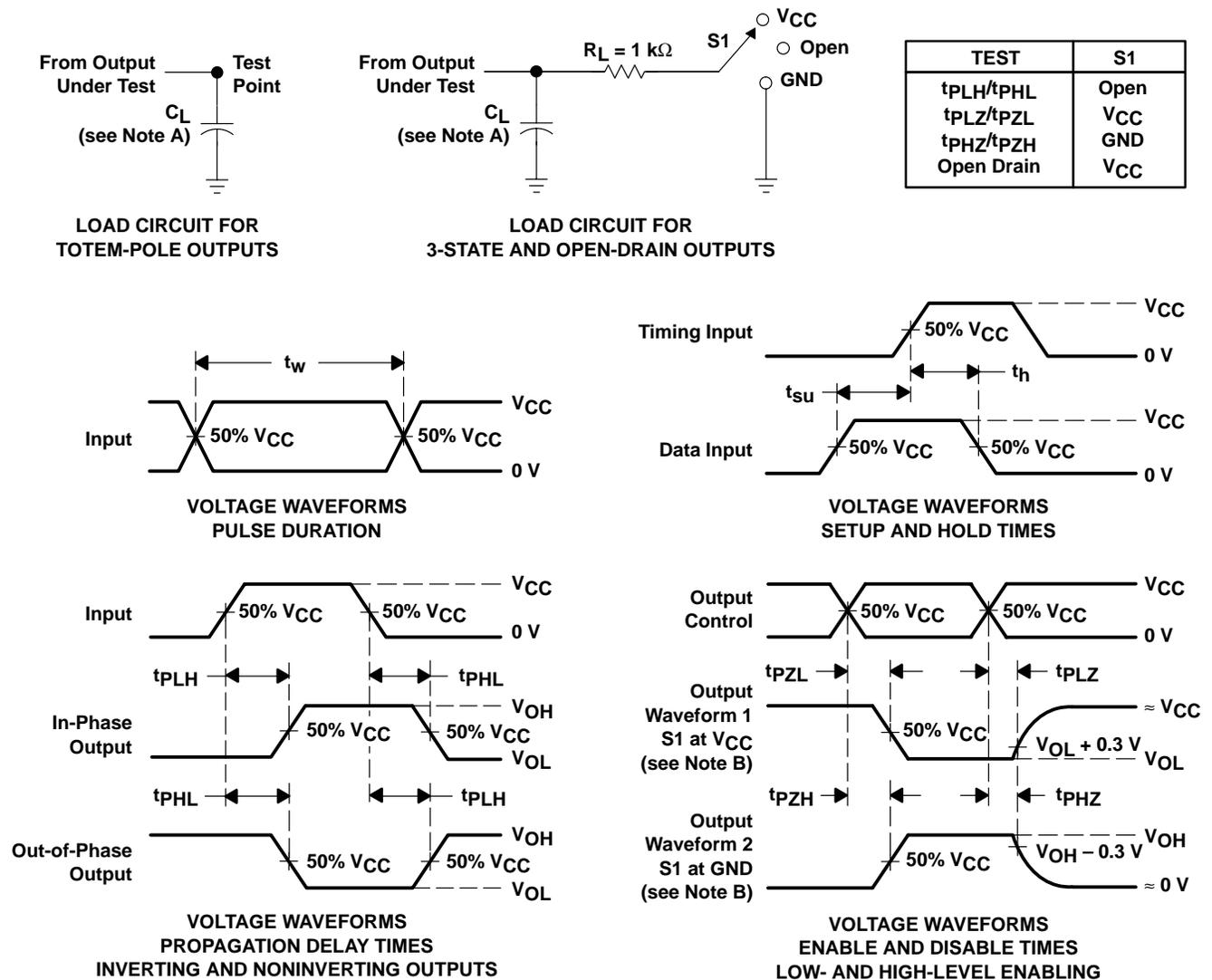
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operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

| PARAMETER |                               | TEST CONDITIONS                                | TYP  | UNIT |
|-----------|-------------------------------|--|------|------|
| $C_{pd}$  | Power dissipation capacitance | Outputs enabled<br>No load, $f = 1\text{ MHz}$ | 22.4 | pF   |

## PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .  
 D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN74AHC367D      | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC367DBR    | ACTIVE                | SSOP         | DB              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC367DBRE4  | ACTIVE                | SSOP         | DB              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC367DE4    | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC367DGV    | ACTIVE                | TVSOP        | DGV             | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC367DGVRE4 | ACTIVE                | TVSOP        | DGV             | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC367DR     | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC367DRE4   | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC367N      | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | Level-NC-NC-NC               |
| SN74AHC367PWR    | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC367PWRE4  | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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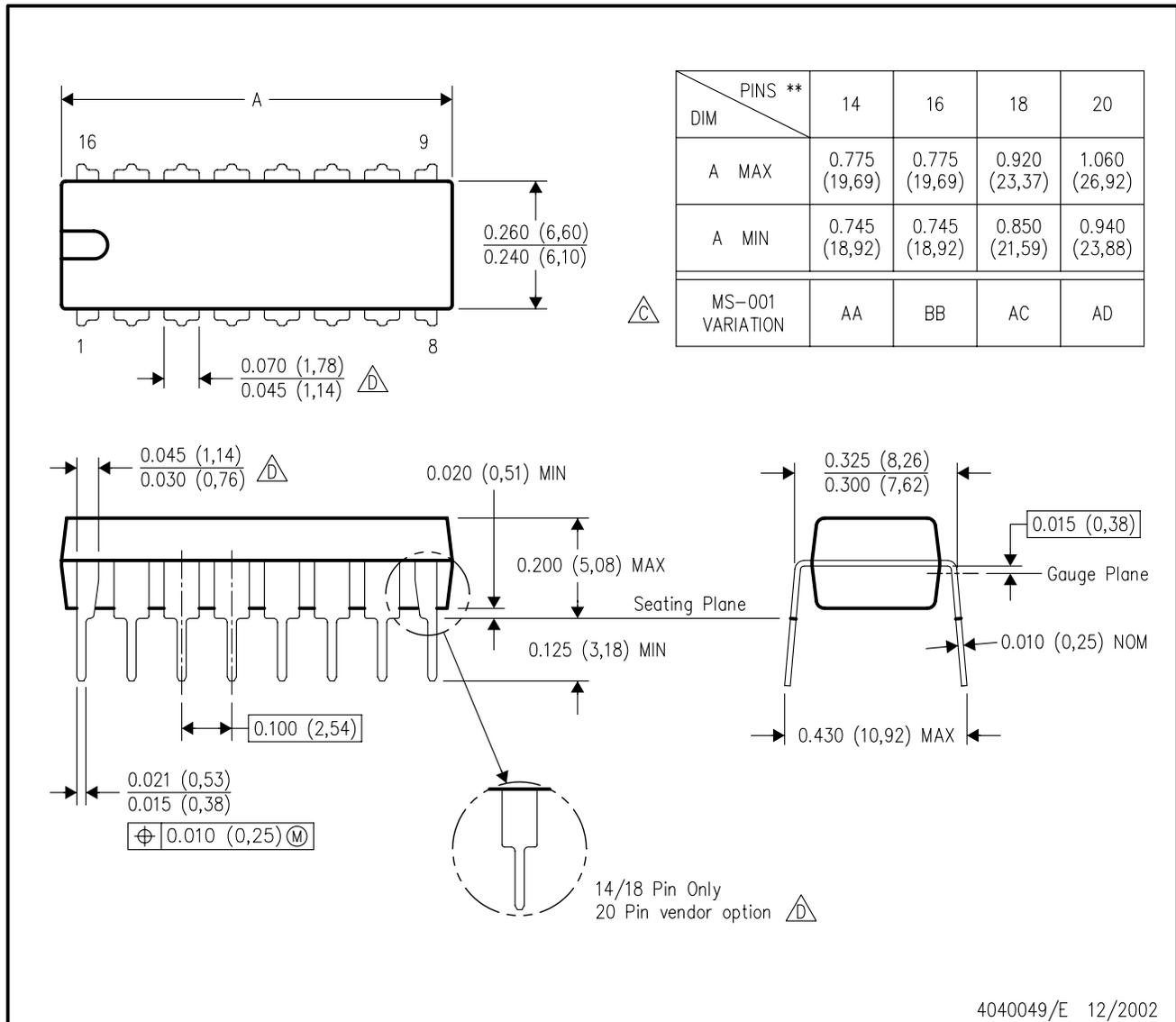
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# MECHANICAL DATA

## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - $\triangle C$  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - $\triangle D$  The 20 pin end lead shoulder width is a vendor option, either half or full width.

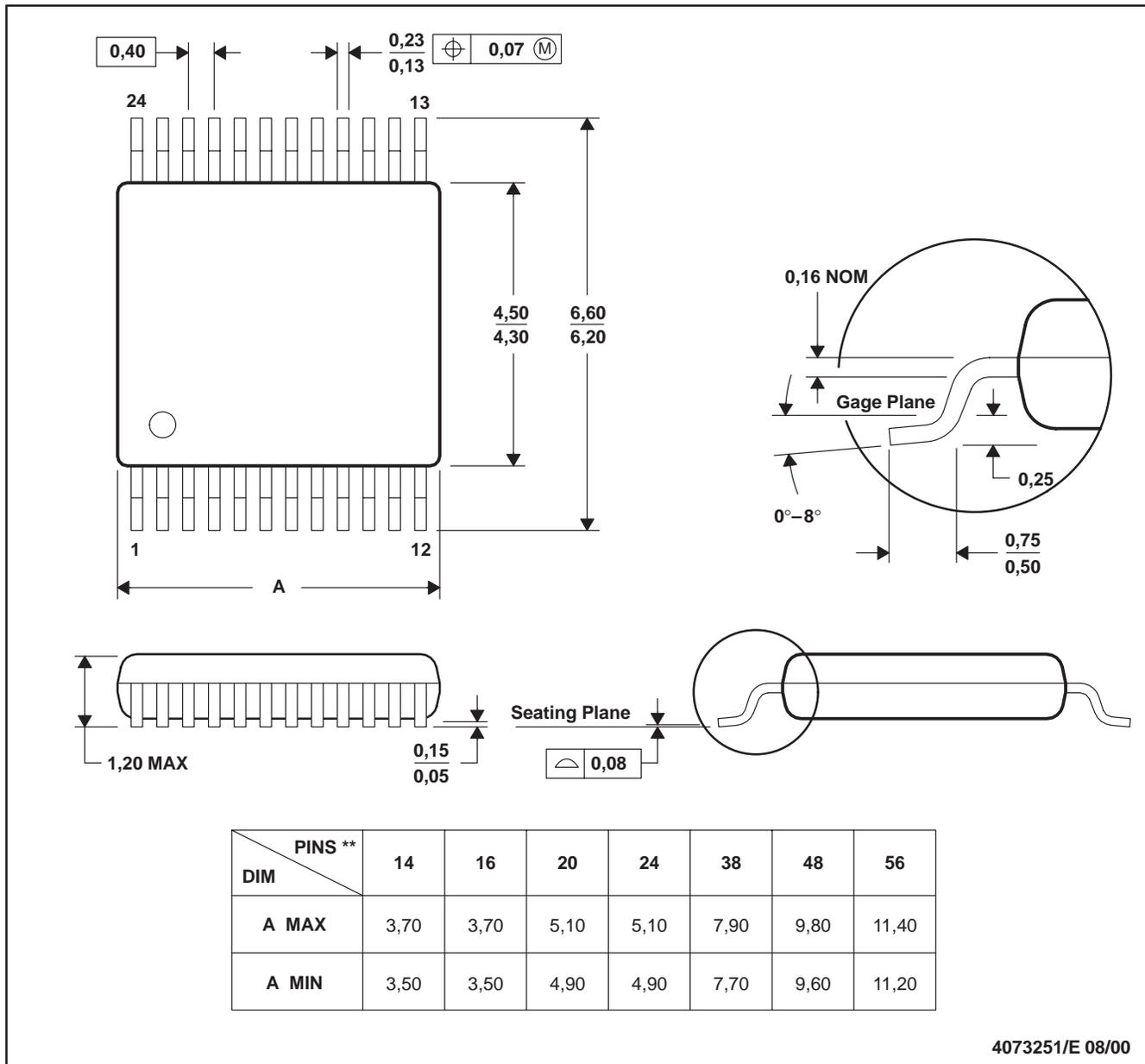
# MECHANICAL DATA

MPDS006C – FEBRUARY 1996 – REVISED AUGUST 2000

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN

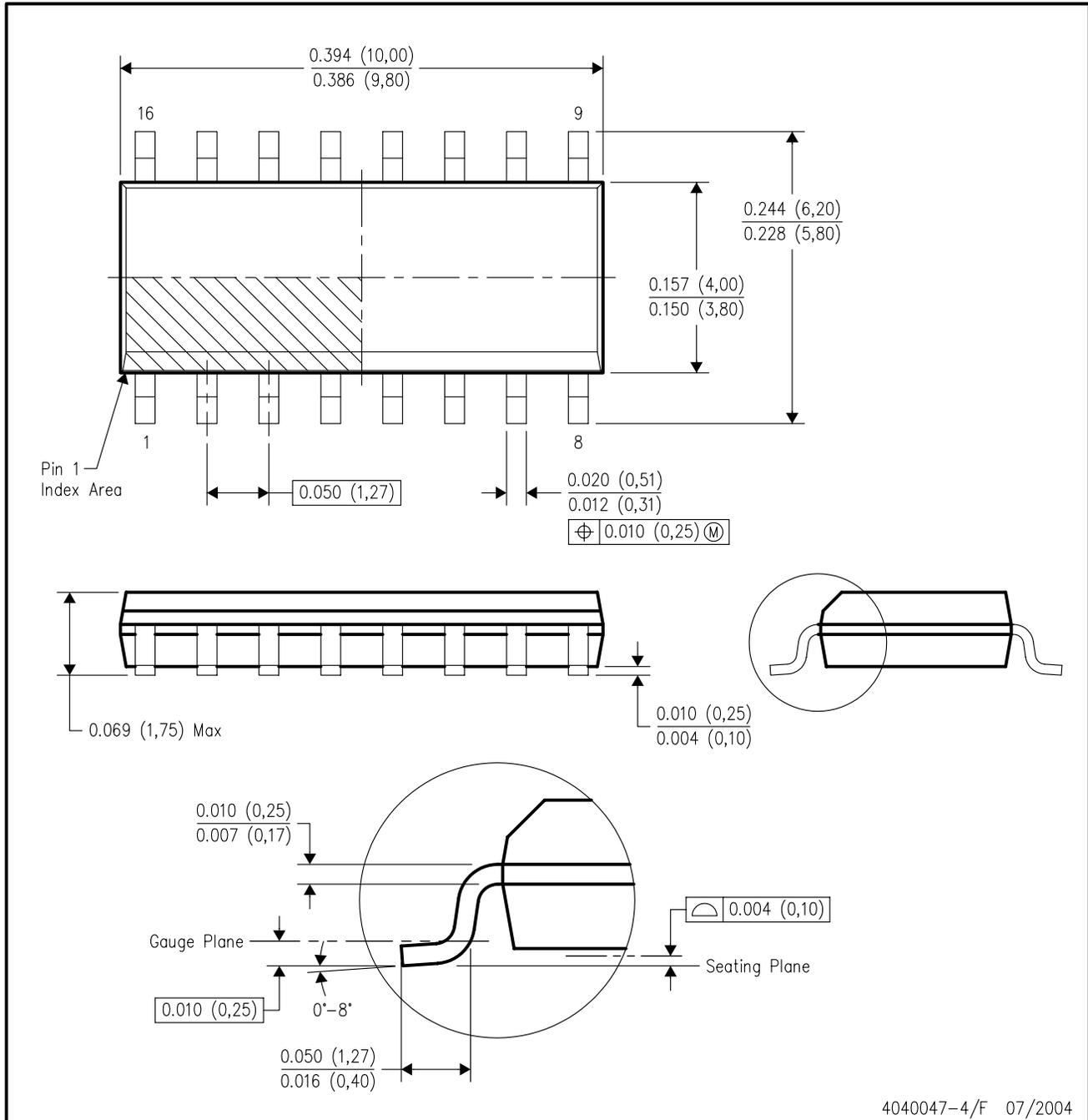


- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

# MECHANICAL DATA

## D (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



4040047-4/F 07/2004

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-012 variation AC.

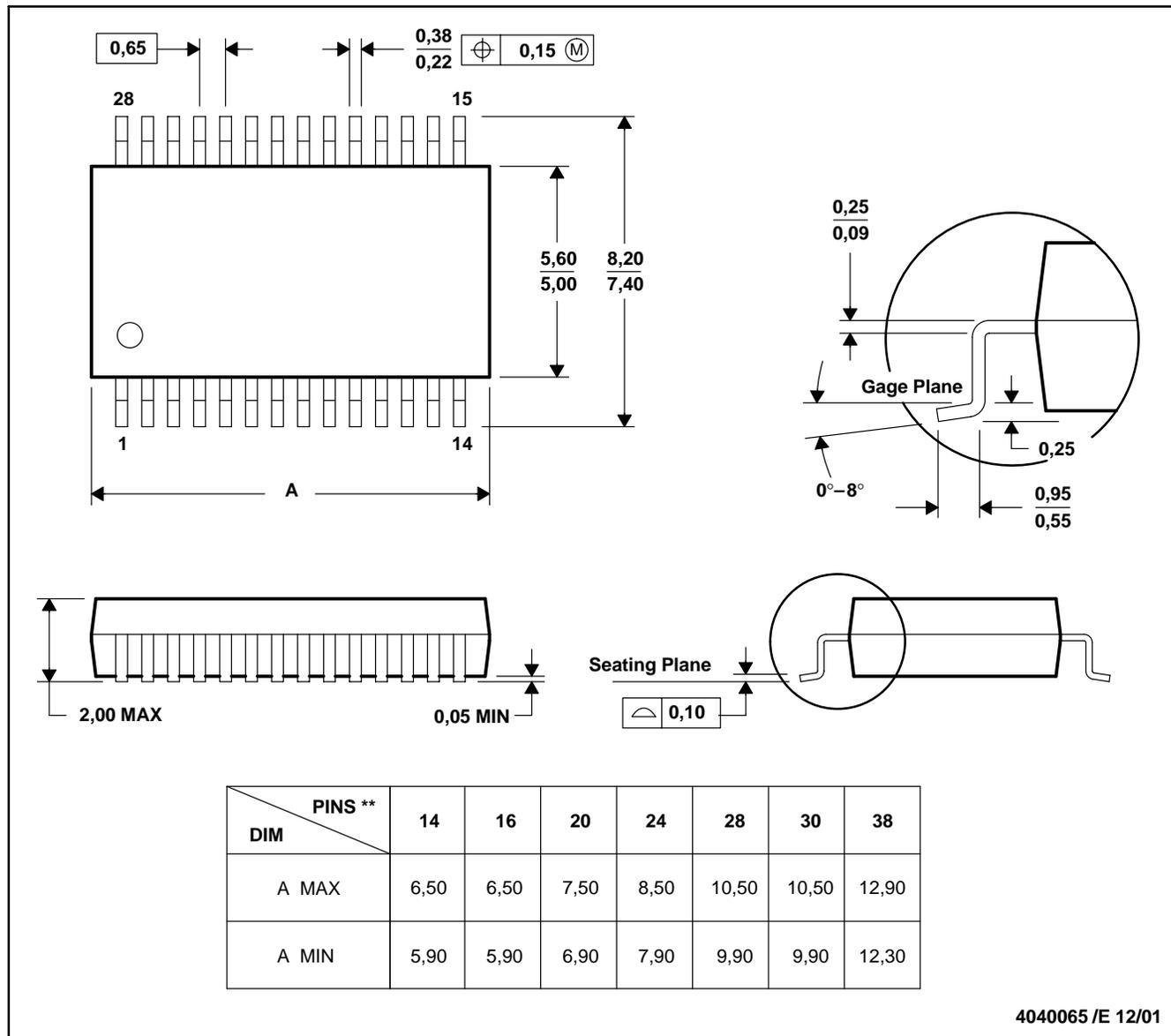
# MECHANICAL DATA

MSS0002E – JANUARY 1995 – REVISED DECEMBER 2001

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

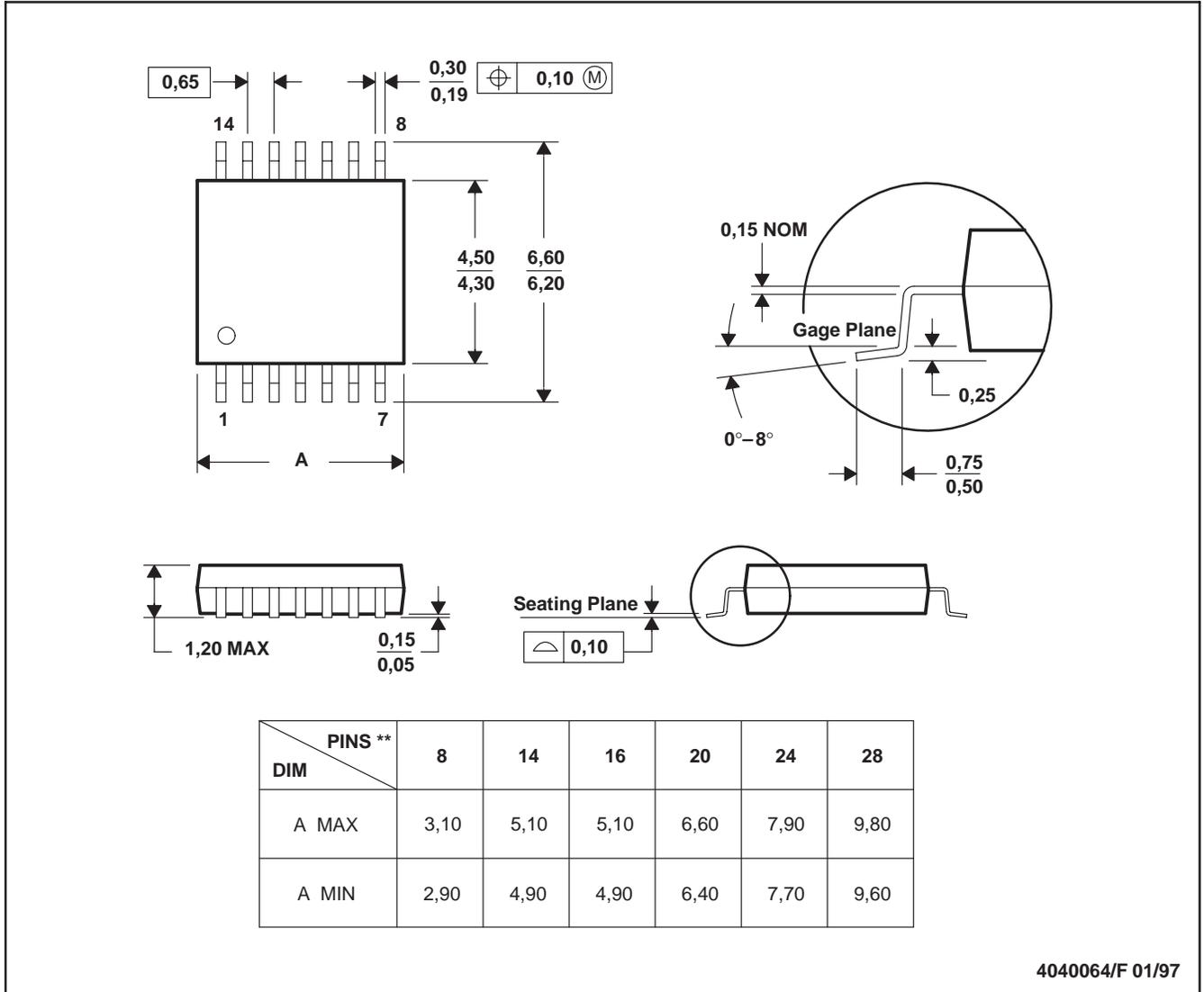
# MECHANICAL DATA

MTSS001C – JANUARY 1995 – REVISED FEBRUARY 1999

**PW (R-PDSO-G\*\*)**

**PLASTIC SMALL-OUTLINE PACKAGE**

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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